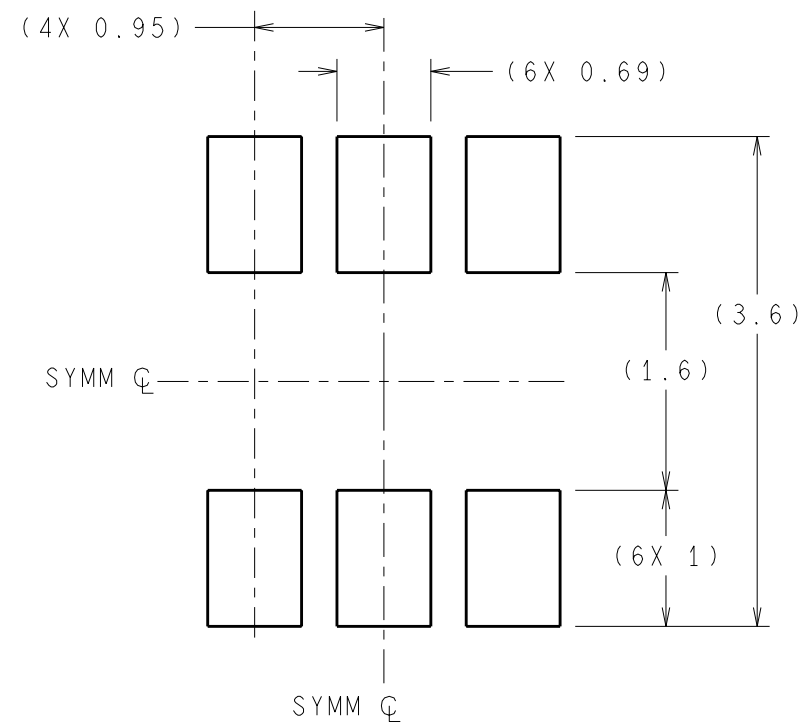
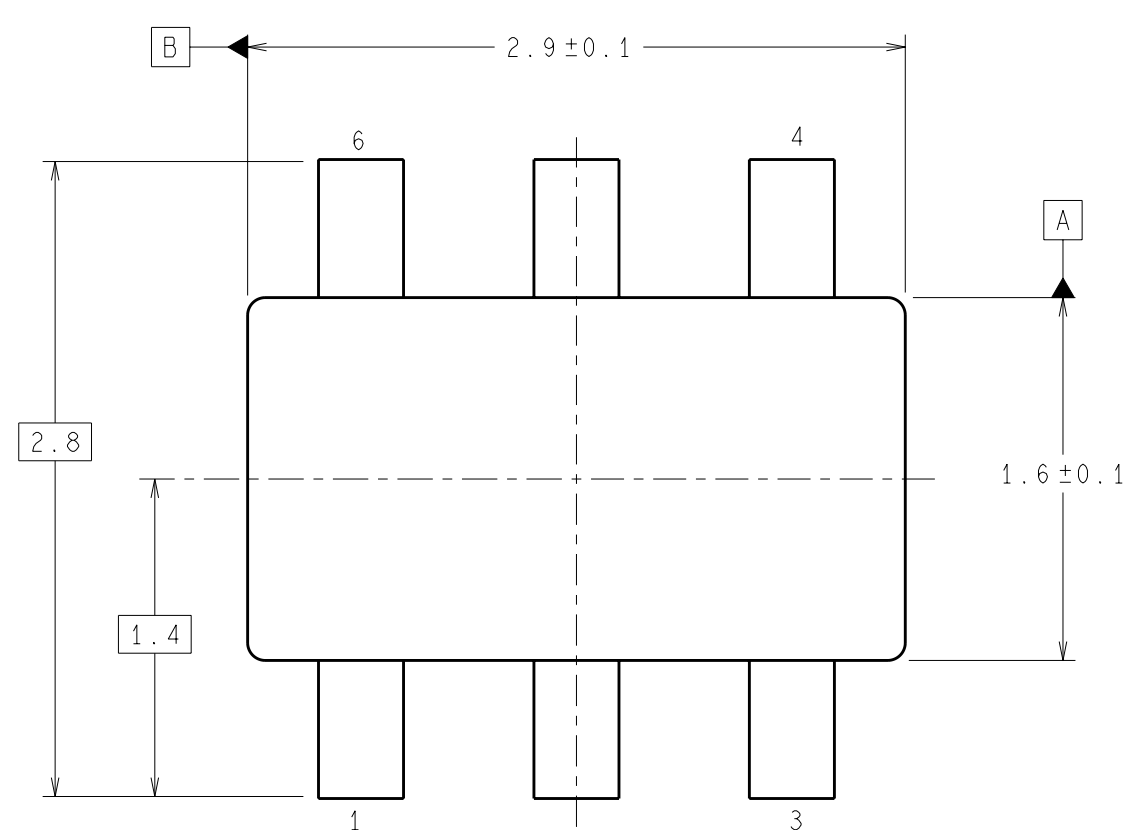
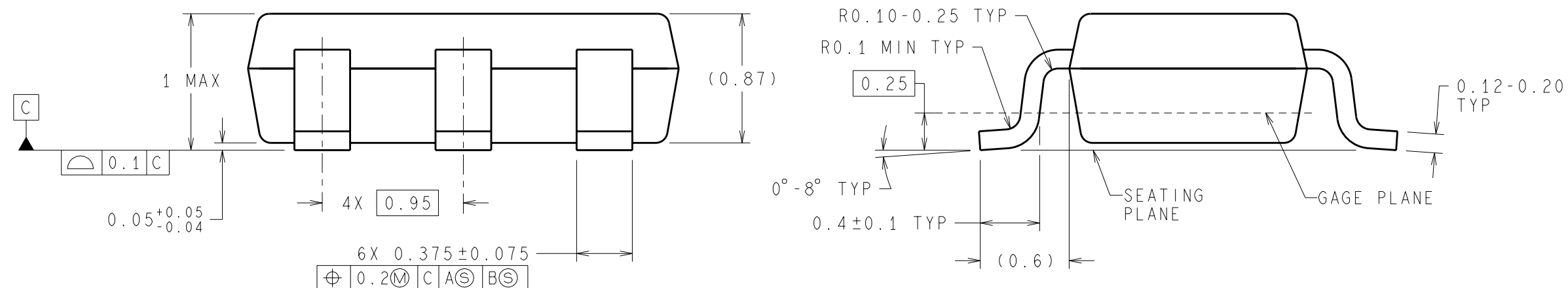


REVISIONS				
REV	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	911	04/02/2003	MS/RW



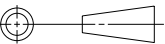
RECOMMENDED LAND PATTERN



DIMENSIONS ARE IN MILLIMETERS

NOTES: UNLESS OTHERWISE SPECIFIED

- FOR LEAD FINISH THICKNESS AND COMPOSITION, SEE "SOLDER INFORMATION" IN THE PACKAGING SECTION OF THE NATIONAL SEMICONDUCTOR WEB PAGE (www.national.com).
- REFERENCE JEDEC REGISTRATION MO-193, VARIATION AA.

APPROVALS		DATE		 National Semiconductor 2900 Semiconductor Dr., Santa Clara, CA 95052-8090	
DRAWN	MARTA SUCHY		04/02/2003		
DFTG. CHK.	THANH LEQUANG		04/02/2003	MOLDED TSOT, 2.9x1.6x0.87mm BODY, 6 LD, 0.95mm PITCH	
ENGR. CHK.	RANDALL WALBERG		04/02/2003		
PROJECTION		SCALE	SIZE	DRAWING NUMBER	REV
 MM		NTS	B	(SC)MKT-MK06A	A
FORMERLY: N/A				SHEET 1 of 1	